

## **EU Declaration of Conformity**

## **Product Safety and EMC Compliance**

The product(s) meets the requirements of The Electromagnetic Compatibility (EMC) Directive 2014/30/EU by application of the following standards:

EN 55032:2012 Electromagnetic compatibility of multimedia equipment - Emission requirements, Class B

EN 55024:2010 Information Technology Equipment – Immunity characteristics – Limits and methods of

measurement

EN 61000-3-2:2014 Limits for harmonic current emissions (equipment input current ≤ 16 A per phase)
EN 61000-3-3:2013 Limits for harmonic current emissions (equipment input current ≤ 16 A per phase)
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Supply Systems for Equipment with Rated Current ≤16 Amps per Phase

The product(s) meets the requirements of The Low Voltage Directive (LVD) 2014/35/EU by application of the following standard:

EN 60950-1:2006 /A11:2009 /A1:2010 /A12:2011/A2:2013 Information Technology Equipment - Safety- (Second Edition) Part 1: General Requirements

## **Product Environmental Compliance**

The product(s) meets the requirements of the RoHS "Recast" Directive 2011/65/EU (RoHS 2) as amended by Directive (EU) 2015/863 and by application of the following standards:

EN 50581:2012 Technical documentation for the assessment of electrical and

electronic products with respect to the restriction of hazardous

substances.

<u>IEC 62321:2015</u> Determination of certain substances in electrotechnical products.

Polybrominated biphenyls and polybrominated diphenyl ethers in polymers by gas chromatography-mass spectrometry (GC-MS).

Seagate products rely on the following RoHS 2 exemptions for compliance:

Exemption Description
(Exemptions are listed per Annex released September 24, 2010)
6a. Lead as an alloying element in steel containing up to 0.35% lead by weight
6b. Lead as an alloying element in aluminum up to 0.4% lead by weight
6c. Lead as an alloying element in copper containing up to 4% lead by weight
7a. Lead in high melting temperature type solders (i.e. lead-based solder alloys containing $85\ \%$ by weight or more lead)
7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors (e.g. piezoelectronic devices) or in a glass or ceramic matrix compound

Year to Begin Affixing Mark: 2015

Manufacturer's Name:Seagate Technology, LLCManufacturer's Address:10200 South De Anza Blvd.

(And Importer) Cupertino, California 95014-3029 U.S.A.

**European Contact:** Director of Operations

Seagate Singapore Int'l HQ Pte. Ltd

Koolhovenlaan 1

1119 NB Schiphol - Rijk

The Netherlands

**Type of Equipment:** Hard Disc Drive **Internal Product Name**: MakaraBP, SATA

Regulatory Model Number: STR00C

This product or products are in conformity with the relevant Union harmonization legislation. This declaration of conformity is issued under the sole responsibility of Seagate Technology LLC.

February 17, 2017 | 08:08:52 PST Date:\_\_\_\_\_

Signature: MEE CRUMP (nump

Mike Crump Vice President Operations Quality